## AMENDMENTS TO THE CLAIMS

- 1. (Currently Amended) A thin-film crystal wafer having a pn junction comprising:
  - a first crystal layer of p GaAs; and
  - a second crystal layer of n  $In_xAl_yGa_{1-x-y}P$  ( $0 \le x \le 1$ ,  $0 \le y \le 1$ , x+y=1),
- the first and second crystal layers being lattice-matched layers that form a heterojunction; wherein
- a thin film layer of  $In_xAl_yGa_{1-x\cdot y}P$  ( $0\le x\le 1$ ,  $0\le y\le 1$ , x+y=1) differing in composition from the n  $In_xAl_yGa_{1-x\cdot y}P$  of the second crystal layer is formed at an interface of the heterojunction first and second crystal layers.
- (Original) A thin-film crystal wafer having a pn junction as claimed in claim 1, wherein the second crystal layer and the thin-film layer each has a y value of 0.
- 3. (Original) A thin-film crystal wafer having a pn junction as claimed in claim 1, wherein the thin-film has a band gap in the range of 1.75 eV-2.10 eV.
- 4. (Original) A thin-film crystal wafer having a pn junction as claimed in claim 1 or 2, wherein the thin-film layer has a thickness of not less than 10 Å and not greater than 100 Å.
- 5. (Original) A thin-film crystal wafer having a pn junction as claimed in claim 1 or 2 wherein the thin-film layer is formed to be considerably thin in comparison with the first and second crystal layers.
- 6. (Original) A method of fabricating a thin-film crystal wafer having a pn junction, for use in fabricating a heterojunction bipolar transistor, by successively overlaying compound semiconductor crystal layers on a GaAs substrate, the method comprising:
  - a step of forming a base layer composed of p GaAs crystal;

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a step of forming on the base layer a thin film layer of  $In_xAl_yGa_{1 \times y}P$  ( $0 \le x \le 1$ ,  $0 \le y \le 1$ , x+y=1) whose lattice constant differs from the lattice constant of the p GaAs crystal layer; and a step of forming on the thin film layer an emitter layer composed of  $n In_xAl_yGa_{1 \times y}P$  ( $0 \le x \le 1$ ,  $0 \le y \le 1$ , x+y=1) crystal whose lattice constant is the same as the lattice constant of the p GaAs crystal layer.

- (Original) A method of fabricating a thin-film crystal wafer having a pn junction as claimed in claim 6, wherein the y value is 0.
- (Original) A method of fabricating a thin-film crystal wafer having a pn junction as claimed in claim 6. wherein the x value of the In component of the emitter layer is 0.48.
- (Original) A method of fabricating a thin-film crystal wafer having a pn junction as claimed in claim 6, wherein the thin-film has a band gap in the range of 1.75 eV-2.10 eV.
- 10. (Original) A method of fabricating a thin-film crystal wafer having a pn junction as claimed in claim 6 or 7, wherein the thin-film layer has a thickness of not less than 10 Å. and not greater than 100 Å.
- 11. (Original) A method of fabricating a thin-film crystal wafer having a pn junction as claimed in claim 6 or 7, wherein the thin-film layer is formed to be considerably thin in comparison with the first and second crystal layers.

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